



### **Features**

- Support IEEE 802.3ah™-2004 1000BASE-PX10-U GEPON ONU side application
- Single fiber bi-directional data links with symmetric
   1.25Gbps upstream and downstream
- Integrated with micro-optics WDM filter for dual wavelength Tx/Rx operation at 1310/1490nm
- 1310nm burst-mode transmitter with FP laser
- 1490nm continuous-mode receiver with PIN-TIA
- 1550nm optical signal rejection
- Digital diagnostic interface compliant with SFF-8472 Rev
   9.5
- Single 3.3V power supply
- Operating case temperature: 0~70°C
- RoHS compliance

## **Regulatory Compliance**

**Table 1 - Absolute Maximum Ratings** 

Feature	Standard	Performance
Electrostatic Discharge	MIL-STD-883E	Class 1(>500 V)
(ESD) to the Electrical Pins	Method 3015.7	Class 1(>500 V)
Electrostatic Discharge (ESD) to the	IEC 61000-4-2	Compatible with standards
Duplex LC Receptacle	IEC 01000-4-2	Compatible with standards
Electromagnetic	FCC Part 15 Class B	Compatible with standards
Interference (EMI)	EN55022 Class B (CISPR 22B)	Compatible with standards
Immunity	IEC 61000-4-3	Compatible with standards
Lagor Eva Safaty	FDA 21CFR 1040.10 and 1040.11	Compatible with Class I laser
Laser Eye Safety	EN60950, EN (IEC) 60825-1,2	product.
Component Recognition	UL and CSA	Compliant with standards
RoHS	2002/95/EC 4.1&4.2	Compliant with standards note
KUNS	2005/747/EC	Compilant with standards

### Note:

In light of item 5 in Annex of 2002/95/EC, "Pb in the glass of cathode ray tubes, electronic components and fluorescent tubes." and item 13 in Annex of 2005/747/EC, "Lead and cadmium in optical and filter glass.", the two exemptions are being concerned for Source Photonics transceivers, because Source Photonics transceivers use glass, which may contain Pb, for components such as lenses, windows, isolators, and other electronic components.



## **Absolute Maximum Ratings**

**Table 2 - Absolute Maximum Ratings** 

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Ambient Temperature	Ts	-40	-	85	°C	
Operating Case Temperature	T <sub>C</sub>	0		70	°C	
Operating Relative Humidity	RH	5		95	%	
Power Supply Voltage	V <sub>CC</sub>	0		4	V	
Input Voltage		GND		V <sub>CC</sub>	V	
Receiver Damaged Threshold		7			dBm	
Soldering Temperature/Time				400/5	°C/s	1
				260/10	°C/s	2

Note 1: Soldering by iron Note 2: Wave soldering

# **Recommended Operating Conditions**

Table 3 – Recommended Operating Conditions

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Power Supply Voltage	V <sub>CC</sub>	3.13	3.3	3.47	V	
Operating Case Temperature	T <sub>C</sub>	0		70	°C	
Operating Relative Humidity	RH	5		95	%	
Data Rate			1.25		Gbit/s	
Data Rate Drift		-100		100	PPM	

# **Optical Characteristics**

**Table 4 – Optical Characteristics** 

Transmitter								
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes		
Centre Wavelength	$\lambda_{C}$	1276		1356	nm			
Optical Spectrum Width (RMS)	Δλ			2.8	nm			
Average Launch Power	P <sub>out</sub>	-1		4	dBm	1		
Average Launch Power-OFF Transmitter	P <sub>OFF</sub>			-45	dBm			
Extinction Ratio	EX	9			dB	2		
Total Jitter	TJ			0.35	UI	2		
Rise/Fall Time (20%-80%)	$T_R/T_F$			260	ps	2,3		



Burst Turn On Time	T <sub>BURST_ON</sub>			30	ns		
Burst Turn Off Time	T <sub>BURST_OFF</sub>			30	ns		
Burst Enable Duration	T <sub>EN_DUR</sub>	600			ns	4	
Burst Disable Duration	T <sub>DIS_DUR</sub>	100			ns		
RIN <sub>15</sub> OMA				-115	dB/Hz		
Optical Return Loss Tolerance				15	dB		
Transmitter Reflectance				-6	dB		
Optical Eye Mask	Co	mpliant With	n IEEE Std 80	2.3ah™-2004	•	2,5	
Receiver							
Operating Wavelength	λ <sub>C</sub>	1480		1500	nm		
Sensitivity	P <sub>SEN</sub>			-26	dBm	6	
Saturation	P <sub>SAT</sub>	-3			dBm		
Signal-Detected Assert Level	P <sub>SDA</sub>			-27	dBm	2	
Signal-Detected Deassert Level	P <sub>SDD</sub>	-39			dBm	3	
Signal-Detected Hysteresis	P <sub>SDA</sub> - P <sub>SDD</sub>	0.5		6	dBm		
Receiver Reflectance				-12	dB		
WDM Filter Isolation	ISO(1550)	38			dB	1550nm	
VVDIVI FIILEI ISOIALIOII	ISO(1650)	35			dB	1650nm	

#### Notes:

- 1. The optical power is launched into 9/125um SMF.
- 2. Measured with PRBS 2<sup>7</sup>-1 test pattern @1.25Gbps.
- 3. Measured with the Bessel-Thompson filter OFF.
- 4. Refer to Timing Parameter Definition in Burst Mode Sequence.
- 5. Transmitter eye mask definition {0.22UI, 0.375UI, 0.20UI, 0.20UI, 0.30UI}.
- 6. Measured with a PRBS 2<sup>7</sup>-1 test pattern @1.25Gbit/s and ER=9dB, BER =10<sup>-12</sup>.
- 7. An increase in optical power above the specified level will cause the Signal Detect output to switch from a low state to a high state.
- 8. A decrease in optical power below the specified level will cause the Signal Detect output to switch from a high state to a low state.

#### **Electrical Characteristics**

**Table 5 – Electrical Characteristics** 

Transmitter							
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes	
Power Supply Current	I <sub>CC_TX</sub>			200	mA		
Data Input Differential Swing	$V_{IN}$	200		1600	mVp-p	1	
Input Differential Impedance	Z <sub>IN</sub>	90	100	110	Ω		
Transmitter Disable Voltage - Low	V <sub>TDIS, L</sub>	0		0.8	V	2	
Transmitter Disable Voltage - High	$V_{TDIS, H}$	2.0		Vcc	V		



Receiver							
Power Supply Current	I <sub>CC_RX</sub>			150	mA		
Data Output Differential Swing	V <sub>out</sub>	400		1600	$mV_{P-P}$	3	
Signal-Detected Voltage - Low	V <sub>SD, L</sub>	0		0.8	V	4	
Signal-Detected Voltage - High	V <sub>SD, H</sub>	2.0		V <sub>CC</sub>	V	4	
Signal-Detected Assert Time	T <sub>ASS</sub>			100	μS		
Signal-Detected Deassert Time	T <sub>DAS</sub>			100	μS		

#### Notes:

- 1. Compatible with LVPECL/CML input, AC coupled internally. (See Recommended Interface Circuit).
- 2. TX\_nBRST (See Pin Function Definitions).
- 3. LVPECL output, AC coupled internally, guaranteed in the full range of input optical power (-3dBm to -27dBm) (See Recommended Interface Circuit).
- 4. SD (See Pin Function Definitions).

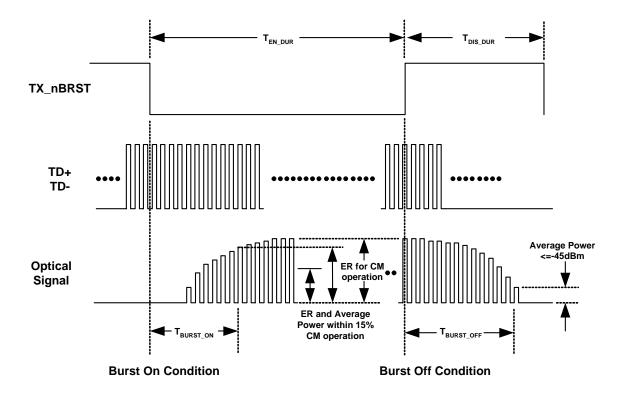
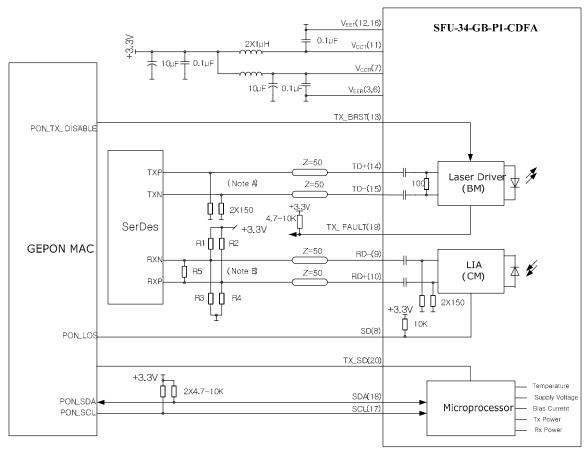


Figure 1, Timing Parameter Definition in Burst Mode Sequence



#### **Recommended Interface Circuit**



Note A: Open emitter output internally.

Note B: LVPECL output, AC coupled internally.

Input stage in SerDes IC is assumed with high impedance and internal bias to Vcc-1.3V

R1=R2=R3=R4=N.C, R5=100  $\Omega$ 

Input stage in SerDes IC is assumed without internal bias to Vcc-1.3V

R1=R2=82  $\Omega$  ,R3=R4=130  $\Omega$  ,R5=N.C

Figure 2, Recommended Interface Circuit

#### **Pin Definitions**

Figure 6 below shows the pin information of electrical interface and mounting studs. Functions are described in Table 7 with some accompanying notes.

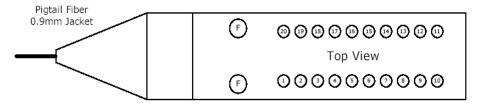


Figure 3, 2×10 SFF Planform

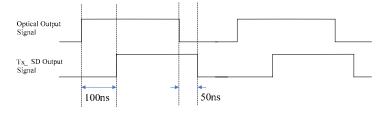


Table 6 -Pin Function Definitions

Pin	Name	Description	Notes
1	NC	No Function Definition	Not connected
2	NC	No Function Definition	Not connected
3	$V_{EER}$	Receiver Signal Ground	
4	NC	No Function Definition	Not connected
5	NC	No Function Definition	Not connected
6	$V_{EER}$	Receiver Signal Ground	
7	$V_{CCR}$	Receiver Power Supply	
8	SD	Receiver Signal-Detected Indication	1
9	RD-	Inverted Receiver Data Output	2
10	RD+	Non-inverted Receiver Data Output	2
11	V <sub>CCT</sub>	Transmitter Power Supply	
12	$V_{EET}$	Transmitter Signal Ground	
13	TX_nBRST	Transmitter Burst Control	3
14	TD+	Transmitter Non-inverted Data Input	4
15	TD-	Transmitter Inverted Data Input	4
16	$V_{EET}$	Transmitter Signal Ground	
17	SCL	Clock Line of the I <sup>2</sup> C interface	5
18	SDA	Data Line of the I <sup>2</sup> C interface	5
19	TX_FAULT	Transmitter Fault Alarm Indication	6
20	TX_SD	Tx Signal Detect	7
MS	MS	Mounting Studs	8
HL	HL	Housing Leads	9

#### Notes:

- 1: LVTTL logic output, with internal  $10K\Omega$  pull-up resistor. Optical Signal-Detected: High; Optical Signal Loss: Low.
- 2: LVPECL logic output, AC coupled internally. (See Recommended Interface Circuit).
- 3: A negative level enable optical signal output under burst mode (See <u>Timing Parameter Definition in Burst Mode Sequence</u>).
- 4: Compatible with LVPECL/CML input, AC coupled internally (See Recommended Interface Circuit).
- 5:  $I^2C$  interface, they should be pulled up with two 4.7-10K $\Omega$  resistors on the host board.
- 6: TTL logic output, pulled up by a 4.7-10k  $\Omega$  pull-up resistor on the host board. Laser Normal State: Low; Laser Failure State: High.
- 7: Tx Signal Detect, Tx Active State: High.



8: The mounting studs are provided for transceiver mechanical attachment to circuit board. They may also



- provide an optional connection of the transceiver to the equipment chassis ground. The holes in the circuit board must be tied to chassis ground. It is not recommended that the mounting studs be connected to signal ground.
- 9: The housing leads may be provided for additional signal grounding. These additional grounds may improve signal integrity, EMC, or ESD performance. The holes in the circuit board must be included and be tied to signal ground.

## **EEPROM Information**

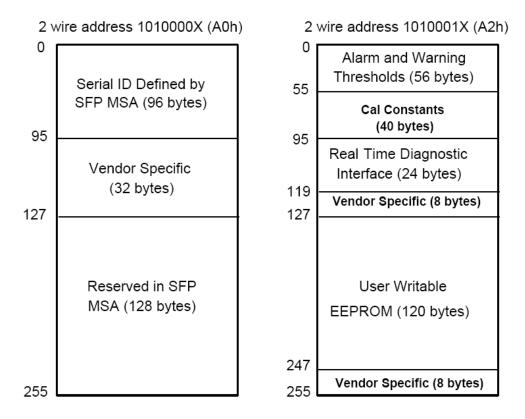


Figure 4, 2-wire Serial Digital Diagnostic Memory Map

Table 7 – EEPROM Serial ID Memory Contents (A0h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description		
0	1	Identifier	02	SFF transceiver		
1	1	Ext. Identifier	04	MOD4		
2	1	Connector	0B	Optical pigtail		
3-10	8	Transceiver	00 00 00 80 00 00 00 00	BASE-PX		
11	1	Encoding	01	8B10B		
12	1	BR, Nominal	0D	1.25Gbps		
13	1	Reserved	00			



14	1	Length (9um)-km	A	10(km)
15	1	Length (9um)	64	100(100m)
16	1	Length (50um)	00	Not Support MMF
17	1	Length (62.5um)	00	Not Support MMF
18	1	Length (Copper)	00	Not Support Copper
19	1	Reserved	00	
20-35	16	Vendor name	53 4F 55 52 43 45 50 48	"SOURCEPHOTONICS"(ASC [])
			4F 54 4F 4E 49 43 53 20	,
36	1	Reserved	00	
37-39	3	Vendor OUI	00 00 00	
40-55	16	Vendor PN	53 46 55 33 34 47 42 50	"SFU34GBP1CDFA" (ASCII)
			31 43 44 46 41 20 20 20	·
56-59	4	Vendor Rev	xx xx 20 20	ASCII("31 30 20 20" means 1.0 Revision)
60-61	2	Wavelength	05 1E	1310nm Laser Wavelength
62	1	Reserved	00	
63	1	CC_BASE	xx	Check sum of byte 0-62
64-65	2	Options	00 06	SD,LAS_FAIL and TX_DISABLE
66	1	BR, max	00	
67	1	BR, min	00	
68-83	16	Vendor SN	XX	ASCII
84-91	8	Date code	xx xx xx xx xx xx 20 20	Year(2 bytes),Month(2 bytes), Day(2 bytes)
92	1	Diagnostic Monitoring Type	68	Compliant with SFF-8472 V9.5 Internally Calibrated Received power measurement type -Average Power
93	1	Enhanced Options	В0	Diagnostics (Optional Alarm/warning flags) Soft TX_FAULT monitoring implemented Soft RX_SD monitoring implemented
94	1	SFF-8472 Compliance	02	Diagnostics Compliance(SFF-8472 V9.5)
95	1	CC_EXT	xx	Check sum of byte 64-94
96-255	64	Vendor Specific		

Note: The "xx" byte should be filled in according to practical case. For more information, please refer to the related document of SFF-8472 Rev 9.5.



Table 8 - Digital Diagnostic Specification (A2h)

Data Address	Data Address Parameter		Accuracy
96-97	Temperature	-40 to 100°C	±3°C
98-99	Vcc Voltage	3.0V to 3.6V	±3%
100-101	Bias Current	0 to 100mA(Note)	±10%
102-103	TX Power	-1 to 4dBm	±3dB
104-105	RX Power	-26 to -3dBm	±2dB

Note: Only for continuous mode

## **Mechanical Diagram**

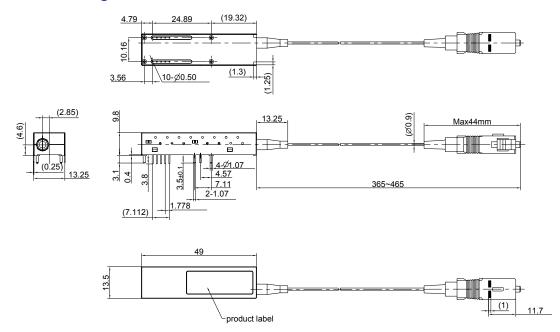


Figure 5, Mechanical Diagram

**Table 9 - Pigtail Fiber Characteristics** 

Parameter	Min.	Typical	Max.	Unit
Mode Field Diameter		9		μm
Cladding Diameter		125		μm
Jacket Diameter		0.9		mm
Bending Radius of Pigtail Fiber	30			Mm
Tension Force on Pigtail Fiber			1	kg
Pigtail Fiber Length	365		465	mm
Optical Return Loss -1310nm	50			dB



## **Order Information**

## **Table 10 – Order Information**

Part No.	Application	Data Rate	Laser Source	Fiber Type
SFU-34-GB-P1-CDFA	1000BASE-PX10 ONU	1.25Gb/s symmetric	1310nm FP	SMF



## **Warnings**

**Handling Precautions:** This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures. **Laser Safety:** Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

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